

MUR220

Preferred Device

SWITCHMODE™ Power Rectifier

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 25 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction

Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 1000 per bag
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: MUR220

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	200 —	Volts
Average Rectified Forward Current (Note 1.) (Square Wave Mounting Method #3 Per Note 3.)	$I_{F(AV)}$	2.0 @ $T_A = 90^\circ\text{C}$	Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I_{FSM}	35	Amps
Operating Junction Temperature and Storage Temperature Range	T_J, T_{stg}	-65 to +175	°C

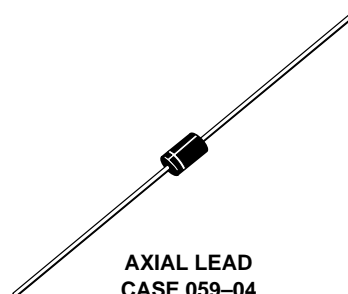
1. Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.



ON Semiconductor™

<http://onsemi.com>

ULTRAFAST
RECTIFIER
2 AMPERES
200 VOLTS



AXIAL LEAD
CASE 059-04
PLASTIC

MARKING DIAGRAM



MUR220 = Device Code

ORDERING INFORMATION

Device	Package	Shipping
MUR220	Axial Lead	1000 Units/Bag
MUR220RL	Axial Lead	5000/Tape & Reel

Preferred devices are recommended choices for future use and best overall value.

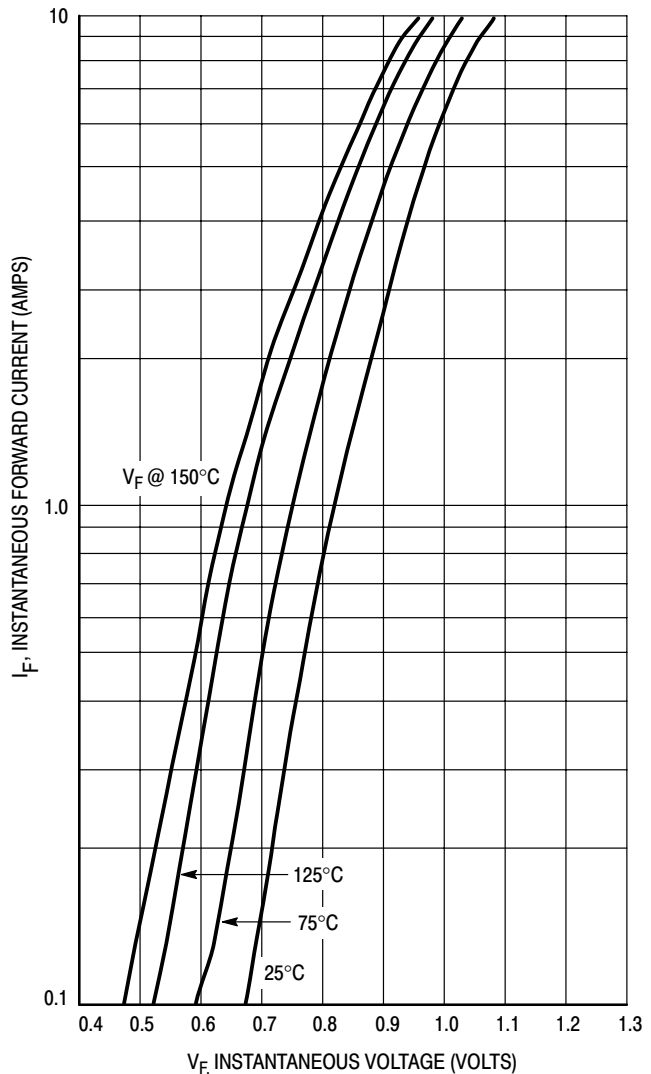
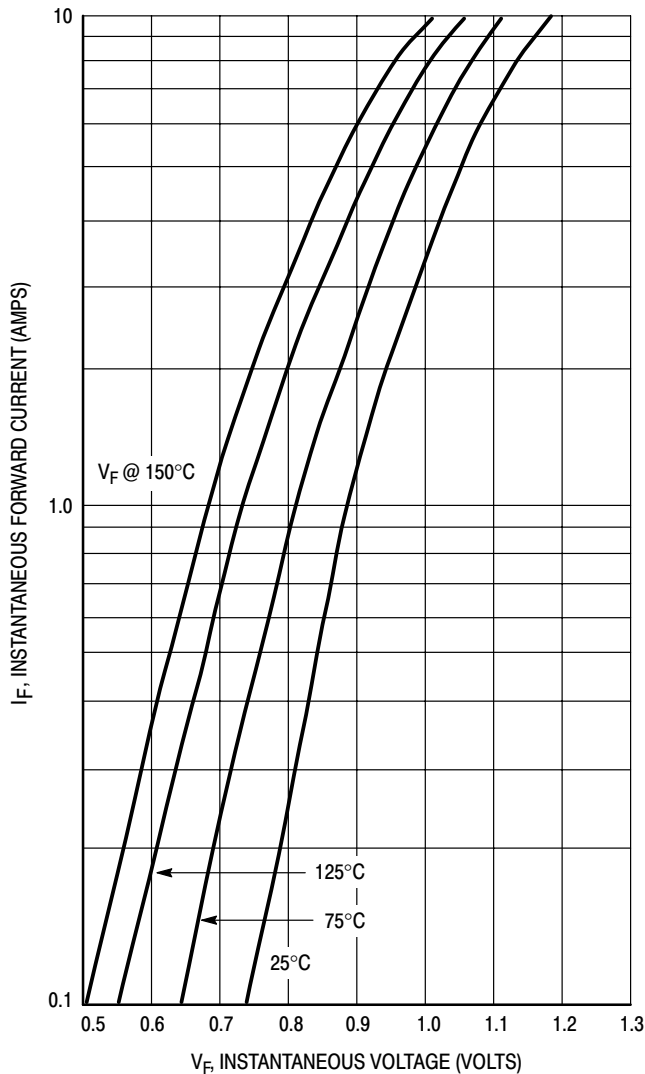
THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	See Note 3.	$^{\circ}\text{C}/\text{W}$

ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 2.) ($I_F = 2.0 \text{ Amp}$, $T_J = 150^{\circ}\text{C}$) ($I_F = 2.0 \text{ Amp}$, $T_J = 25^{\circ}\text{C}$)	V_F	0.75 0.95	Volts
Maximum Instantaneous Reverse Current (Note 2.) (Rated dc Voltage, $T_J = 150^{\circ}\text{C}$) (Rated dc Voltage, $T_J = 25^{\circ}\text{C}$)	i_R	50 2.0	μA
Maximum Reverse Recovery Time ($I_F = 1.0 \text{ Amp}$, $di/dt = 50 \text{ Amp}/\mu\text{s}$) ($I_F = 0.5 \text{ Amp}$, $I_R = 1.0 \text{ Amp}$, $I_{REC} = 0.25 \text{ A}$)	t_{rr}	35 25	ns
Maximum Forward Recovery Time ($I_F = 1.0 \text{ A}$, $di/dt = 100 \text{ A}/\mu\text{s}$, I_{REC} to 1.0 V)	t_{fr}	25	ns

2. Pulse Test: Pulse Width = 300 μs , Duty Cycle $\leq 2.0\%$.



MUR220

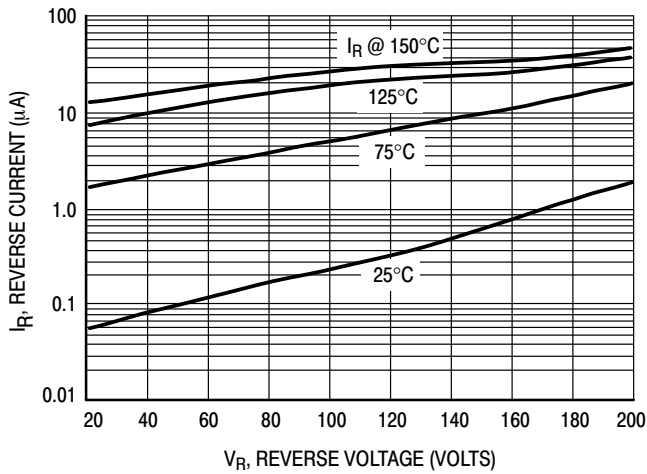


Figure 3. Maximum Reverse Current

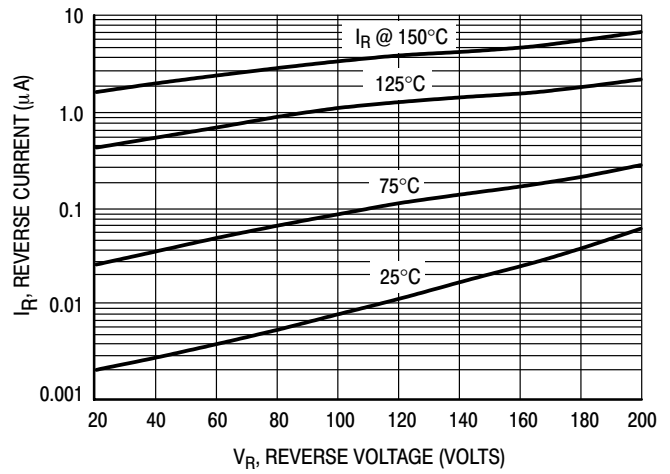


Figure 4. Typical Reverse Current

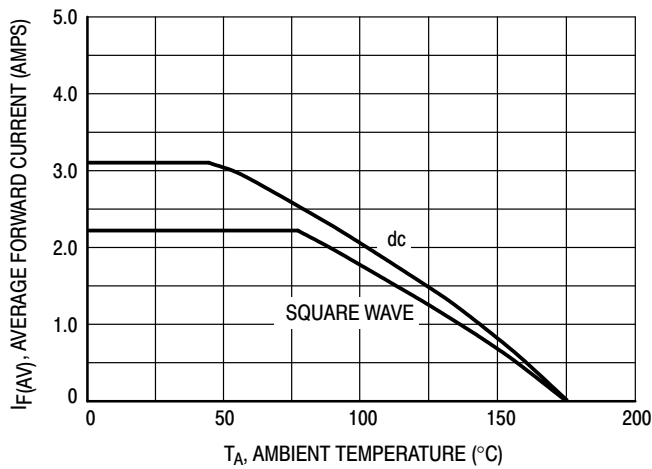


Figure 5. Current Derating

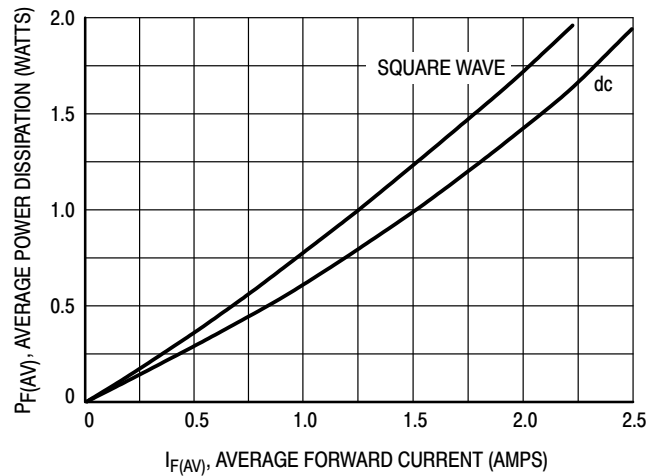


Figure 6. Power Dissipation

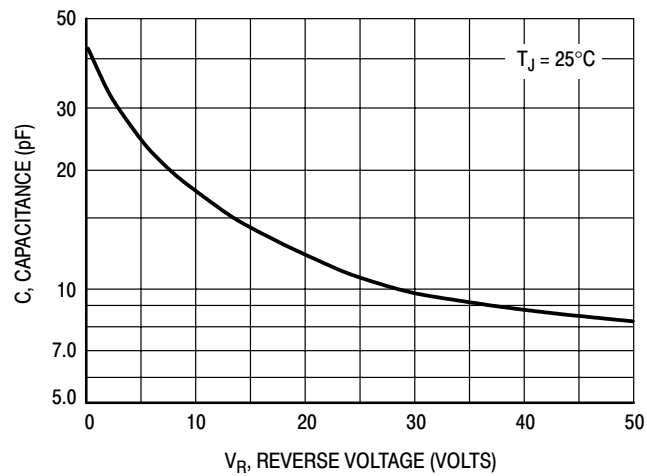


Figure 7. Typical Capacitance

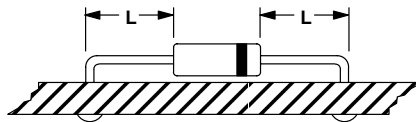
NOTE 3. – AMBIENT MOUNTING DATA

Data shown for thermal resistance junction to ambient ($R_{\theta JA}$) for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

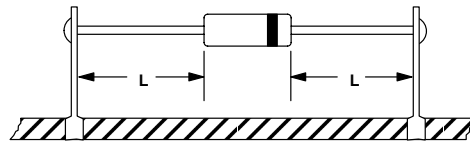
TYPICAL VALUES FOR $R_{\theta JA}$ IN STILL AIR

Mounting Method		Lead Length, L			Units
		1/8	1/4	1/2	
1	$R_{\theta JA}$	52	65	72	$^{\circ}\text{C/W}$
2		67	80	87	$^{\circ}\text{C/W}$
3		50			$^{\circ}\text{C/W}$

MOUNTING METHOD 1

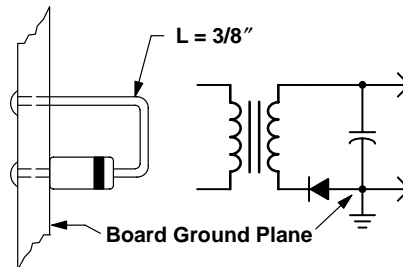


MOUNTING METHOD 2



Vector Pin Mounting

MOUNTING METHOD 3



P.C. Board with 1-1/2" X 1-1/2" Copper Surface

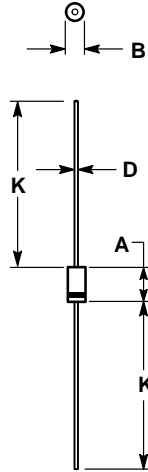
MUR220

PACKAGE DIMENSIONS

MINI MOSORB

CASE 59-04

ISSUE M



NOTES:

1. ALL RULES AND NOTES ASSOCIATED WITH JEDEC DO-41 OUTLINE SHALL APPLY.
2. POLARITY DENOTED BY CATHODE BAND.
3. LEAD DIAMETER NOT CONTROLLED WITHIN F DIMENSION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	5.97	6.60	0.235	0.260
B	2.79	3.05	0.110	0.120
D	0.76	0.86	0.030	0.034
K	27.94	---	1.100	---

Notes

Notes

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Phone: 303-675-2121 (Tue-Fri 9:00am to 1:00pm, Hong Kong Time)
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Email: ONlit-asia@hibbertco.com

JAPAN: ON Semiconductor, Japan Customer Focus Center

4-32-1 Nishi-Gotanda, Shinagawa-ku, Tokyo, Japan 141-0031
Phone: 81-3-5740-2700
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